## 

| Designator | Quantity | Value | Description | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | ernate Manufacture |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| !PCB1 | 1 |  | Printed Circuit Board |  | PWR763 | Any |  |  |
| Aarvark | 1 |  | Aardvark embedded systems interface |  | TP240141 | Total Phase |  | - |
| C6, C7, C8, C9 | 4 | 3300pF | CAP, CERM, 3300 pF, 50 <br> V, +/-10\%, X7R, 0603 | 0603 | GRM188R71H332KA01 D | MuRata |  |  |
| C14, C17, C18, <br> C20, C21, C25, <br> C26, C28, C29, <br> C40, C41, C42, <br> C44, C46, C48, <br> C51, C52, 54, <br> C55, C57, C60, <br> C66, C67, C78, <br> C79, C80, C82, <br> C84, C86, C89, <br> C90, C92, C93, <br> C95, C98, C100, <br> C101, C107, <br> C113, C114, <br> C116, C118, <br> C120, C121, <br> C122, C123, <br> C124, C125, <br> C129, C132, C133 | 51 | 0.1uF | $\begin{aligned} & \text { CAP, CERM, } 0.1 \mu \mathrm{~F}, 50 \\ & \mathrm{~V},+/-10 \%, \text { X7R, } 0603 \end{aligned}$ | 0603 | 06035C104KAT2A | AVX |  |  |
| $\begin{aligned} & \hline \text { C22, C23, C58, } \\ & \text { C59, C96, C97 } \end{aligned}$ | 6 | 0.047uF | $\begin{aligned} & \text { CAP, CERM, } 0.047 \mu \mathrm{~F}, \\ & 16 \mathrm{~V},+/-10 \%, \text { X7R, } 0603 \end{aligned}$ | 0603 | GRM188R71C473KA01 | MuRata |  |  |
| C34, C69, C103 | 3 | 0.14F | $\begin{aligned} & \text { CAP, CERM, } 0.1 \mu \mathrm{~F}, 100 \\ & \mathrm{~V},+\mathrm{l}-10 \%, \mathrm{X} 7 \mathrm{R}, 0603 \end{aligned}$ | 0603 | GRM188R72A104KA35D | MuRata |  |  |
| C35, C36, C37, C38, C62, C63, C64, C65, C73, C74, C75, C76, C108, C109, C110 C111 | 16 | 33 pF | CAP, CERM, 33 pF, 50 V, +/-5\%, COG/NPO, 0603 | 0603 | GRM1885C1H330JA01D | MuRata |  |  |
| $\begin{gathered} \text { C39, C77, C112, } \\ \text { C126, C135 } \\ \hline \end{gathered}$ | 5 | 10uF | CAP, CERM, $10 \mu \mathrm{~F}, 10$ V, +/- 20\%, X7R, 0805 | 0805 | C2012X7R1A106M125A | TDK |  |  |
| $\begin{array}{\|c\|} \hline \mathrm{C} 43, \mathrm{C} 45, \mathrm{C} 47, \\ \mathrm{C} 81, \mathrm{C} 83, \mathrm{C} 85, \\ \mathrm{C} 115, \mathrm{C} 117, \mathrm{C} 119 \end{array}$ | 9 | 2.2uF | $\begin{aligned} & \text { CAP, CERM, } 2.2 \mu \mathrm{~F}, 10 \\ & \mathrm{~V},+/-10 \%, \text { X7R, } 0805 \end{aligned}$ | 0805 | GRM21BR71A225KA01L | MuRata |  |  |
| C127 | 1 | 1uF | $\begin{aligned} & \text { CAP, CERM, } 1 \mu \mathrm{~F}, 16 \mathrm{~V}, \\ & +/-10 \%, \text { X7R, } 0603 \\ & \hline \end{aligned}$ | 0603 | C1608X7R1C105K | TDK |  |  |
| $\begin{aligned} & \hline \text { C128, C130, } \\ & \text { C131, C134 } \\ & \hline \end{aligned}$ | 4 | 4.7uF | $\begin{aligned} & \text { CAP, CERM, } 4.7 \mu \mathrm{~F}, 10 \\ & \mathrm{~V},+/-10 \%, \mathrm{X} 5 \mathrm{R}, 0603 \end{aligned}$ | 0603 | C0603C475K8PACTU | Kemet |  |  |
| C136 | 1 | 150pF | CAP, CERM, $150 \mathrm{pF}, 50$ V, +/-5\%, COG/NPO, 0603 | 0603 | C0603C151J5GACTU | Kemet |  |  |
| C137 | 1 | 1000pF | CAP, CERM, 1000 pF, $3150 \mathrm{~V},+80 /-20 \%$, , Radial Disc D7x6mm | Radial Disc D7x6mm | DEBE33F102ZC3B | MuRata |  |  |
| D1, D2, D3 | 3 | Yellow | LED, Yellow, SMD | 0603(1608) | APT1608SYCK | Kingbright |  |  |




| R215 | 1 | 1.0 | $\begin{array}{\|} \text { RES, } 1.0,5 \%, 0.1 \mathrm{~W}, \\ 0603 \end{array}$ | 0603 | \|CRCW06031R00JNEA | Vishay-Dale |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RT1, RT2, RT3, RT4, RT5, RT6 | 6 | 10.0k ohm | Thermistor NTC, 10.0k ohm, 1\%, 0603 | 0603 | ERT-JIVG103FA | Panasonic |  |  |
| SH-J1, SH-J2, SH- J3, SH-J4, SH-J5, SH-J6, SH-J7, SH- J8, SH-JP1, SH- JP2, SH-JP3, SH- JP4, SH-JP5, SH- JP6, SH-JP7, SH- JP8, SH-JP9, SH- JP10, SH-JP11, SH-JP12, SH- JP13, SH-JP14, SH-JP15, SH- JP16, SH-JP17, SH-JP18, SH- JP19 | 27 | 1×2 | Shunt, 100mil, Gold plated, Black | Shunt | 969102-0000-DA | 3M | SNT-100-BK-G | Samtec |
| T1 | 1 | 400 uH | $\begin{aligned} & \text { Transformer, } 400 \mathrm{uH}, \\ & \text { SMT } \\ & \hline \end{aligned}$ | $6.6 \times 6.99 \mathrm{~mm}$ | Q4470-CLB | Coilcraft |  |  |
| TP1, TP2, TP3, TP4, TP5, TP6, TP 1, TP-2, TP-3, TP4, TP-5, TP-6, TP7, TP-8, TP-9, TP10, TP-11, TP-12, TP-13, TP-14, TP15, TP-16, TP-17, TP-18, TP-19, TPAGN, TP-C1, TPC2, TP-C3, TP-C4, TP-C5, TP-C6, TPSW1, TPVPROG1, TPVPROG2, TPVPROG3, TPVSS1, TP-VSS2, TP-VSS3, TPTPVSS1 | 40 | SMT | Test Point, Miniature, SMT | Testpoint_Keystone_Miniature | 5015 | Keystone |  |  |
| U1, U2, U3 | 3 |  | 3 to 6 Series Cell LithiumIon Battery Monitor and Secondary Protection IC for EV \& HEV Applications, -40 to 105 degC, 64-pin HTQFP (PAP), Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | PAP0064F | BQ76PL536ATPAPRQ1 | Texas Instruments | Equivalent | None |
| U4, U6 | 2 |  | 25 Mbps Quad Channels, 3/1, Digital Isolator, 3.3 V/5 V, -40 to +125 degC, 16-pin SOIC (DW), Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | DW0016A | ISO7241CDW | Texas Instruments | Equivalent | Texas Instruments |
| U5 | 1 |  | Remote 8-Bit I2C and SMBus Low-Power I/O Expander with Reset and Configuration Registers, 2.3 to $5.5 \mathrm{~V},-40$ to 85 degC, 16 -pin TSSOP (PW), Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | PW0016A | PCA9557PWR | Texas Instruments | Equivalent | Texas Instruments |


| U7 | 1 |  | \|Single Output LDO, 100 mA, Fixed 3.3 V Output, 2.7 to 10 V Input, with Low IQ, 5-pin SOT-23 (DBV), -40 to 125 degC, Green (RoHS \& no Sb/Br) | DBvo005A | \|TPS76933DBVR | Texas Instruments | Equivalent | Texas Instruments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| U8 | 1 |  | LOW POWER CURRENT MODE PUSHPULL PWM, D0008A | D0008A | UCC2808DTR-2 | Texas Instruments | UCC2808D-2 | Texas Instruments |
| U9 | 1 |  | Ultralow-Power 100-mA Low-Dropout Linear Regulators, DBV0005A | DBV0005A | TPS76901DBV | Texas Instruments |  | Texas Instruments |
|  | 36 | 5.6 V | $\begin{aligned} & \text { Diode, Zener, } 5.6 \mathrm{~V}, 500 \\ & \mathrm{~mW}, \text { SOD-123 } \end{aligned}$ | SOD-123 | MMSZ5232B-7-F | Diodes Inc. |  |  |
| $\begin{gathered} \hline \mathrm{C} 1, \mathrm{C} 2, \mathrm{C} 3, \mathrm{C} 4, \\ \mathrm{C} 5, \mathrm{C10,} \mathrm{C11,} \\ \text { C12, C13 } \\ \hline \end{gathered}$ | 0 | 0.1uF | $\begin{aligned} & \text { CAP, CERM, } 0.1 \mu \mathrm{~F}, 50 \\ & \mathrm{~V},+/-10 \%, \text { X7R, } 0603 \end{aligned}$ | 0603 | 06035C104KAT2A | AVX |  |  |
| C15, C16, C19, <br> C24, C27, C30, <br> C49, C50, C53, <br> C56, C61, C68, <br> C87, C88, C91, <br> C94, C99, C102 <br> C | 0 | 0.1uF | $\begin{aligned} & \text { CAP, CERM, } 0.1 \mu \mathrm{~F}, 100 \\ & \mathrm{~V},+\mathrm{l}-10 \%, \mathrm{X} 7 \mathrm{R}, 0603 \end{aligned}$ | 0603 | GRM188R72A104KA35D | MuRata |  |  |
| $\begin{array}{\|c\|} \hline \mathrm{C} 31, \mathrm{C} 32, \mathrm{C} 3, \\ \mathrm{C} 70, \mathrm{C} 71, \mathrm{C} 72, \\ \mathrm{C} 104, \mathrm{C} 105, \mathrm{C} 106 \end{array}$ | 0 | 0.14F | $\begin{aligned} & \text { CAP, CERM, 0.1 } \mu \mathrm{F}, 16 \\ & \mathrm{~V},+/-10 \%, \text { X7R, } 0603 \end{aligned}$ | 0603 | C0603C104K4RACTU | Kemet |  |  |
| FID1, FID2, FID3 | 0 |  | Fiducial mark. There is nothing to buy or mount. | Fiducial | N/A | N/A |  |  |
| $\begin{gathered} \text { R1, R10, R11, } \\ \text { R12, R54, R55, } \\ \text { R56, R65 } \\ \hline \end{gathered}$ | 0 | 1.00k | $\begin{aligned} & \text { RES, } 1.00 \mathrm{k}, 1 \%, 0.25 \mathrm{~W} \\ & 1206 \end{aligned}$ | 1206 | CRCW12061K00FKEA | Vishay-Dale |  |  |
| R20, R37, R94, <br> R99, R103, R104, <br> R105, R106, <br> R140, R144, <br> R177, R179, <br> R184, R198, <br> R199, R200 | 0 | 0 | RES, 0, 5\%, 0.1 W, 0603 | 0603 | CRCW06030000Z0EA | Vishay-Dale |  |  |
| Z1, Z15, 227 | 0 | 36 V | $\begin{aligned} & \text { Diode, TVS, Bi, } 36 \text { V, } 400 \\ & \text { W, SMA } \end{aligned}$ | SMA | SMAJ36CA | Littelfuse |  |  |

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